SE20FD, SE20FG, SE20FJ

Vishay General Semiconductor

AUTOMOTIVE GRADE

COMPLIANT

HALOGEN

Surface-Mount Standard Rectifiers

eSMP® Series



SMF (DO-219AB)

Bottom view

Cathode O Anode

LINKS TO ADDITIONAL RESOURCES

Top view



PRIMARY CHARACTERISTICS					
I _{F(AV)}	2.0 A				
V_{RRM}	200 V, 400 V, 600 V				
I _{FSM}	35 A				
V_F at $I_F = 2.0$ A $(T_A = 125 ^{\circ}C)$	0.85 V				
I _R	5 μΑ				
T _J max.	175 °C				
Package	SMF (DO-219AB)				
Circuit configuration	Single				

FEATURES

- Low profile package
- · Ideal for automated placement
- Oxide planar chip junction
- · Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- · Wave and reflow solderable
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - for, halogen-free, and RoHS-compliant

Base P/NHM3 - for halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	SE20FD	SE20FG	SE20FJ	UNIT
Device marking code		CD	CG	CJ	
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Maximum DC forward current	I _{F(AV)} (1)	2.0			- A
Maximum DC forward current	I _{F(AV)} (2)	1.7			
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	35		А	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175		°C	

Notes

- (1) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB
- (2) Free air, mounted on recommended copper pad area

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	1 - 20 4	T _A = 25 °C	V _E ⁽¹⁾	0.96	1.10	V
	I _F = 2.0 A	T _A = 125 °C	VF(')	0.85	1.00	
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	5	μА
		T _A = 125 °C	IR (-)	7.6	100	
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	920	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	13	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)					
PARAMETER	SYMBOL	MBOL SE20FD SE20FG SE20FJ UNI			
Typical thermal resistance	R _{0JA} (1)	130		°C/W	
Typical thermal resistance	R _{0JM} (1)		20		C/VV

Note

 $^{(1)} \ \ \text{Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance } \ R_{\theta JA} \ \text{- junction to ambient; } \ R_{\theta JM} \ \text{- junction to mount}$

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$ unless otherwise noted)					
STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VA				VALUE	
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ	V _C	НЗВ	> 8 kV

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SE20FJ-M3/H	0.015	Н	3000	7" diameter plastic tape and reel	
SE20FJ-M3/I	0.015	I	10 000	13" diameter plastic tape and reel	
SE20FJHM3/H ⁽¹⁾	0.015	Н	3000	7" diameter plastic tape and reel	
SE20FJHM3/I (1)	0.015	I	10 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

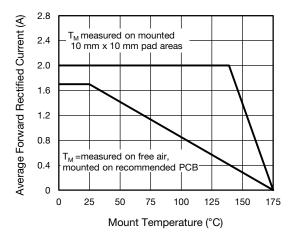


Fig. 1 - Maximum Forward Current Derating Curve

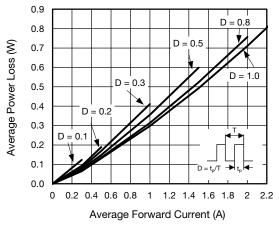


Fig. 2 - Average Power Loss Characteristics

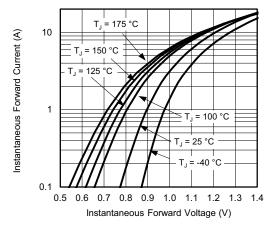


Fig. 3 - Typical Instantaneous Forward Characteristics

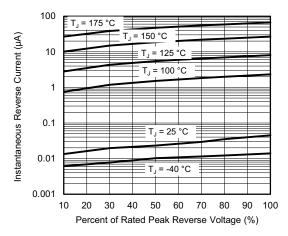


Fig. 4 - Typical Reverse Leakage Characteristics

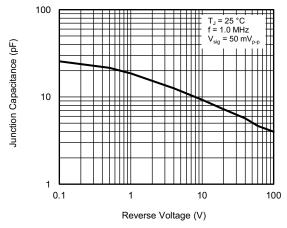


Fig. 5 - Typical Junction Capacitance

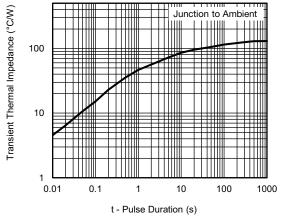
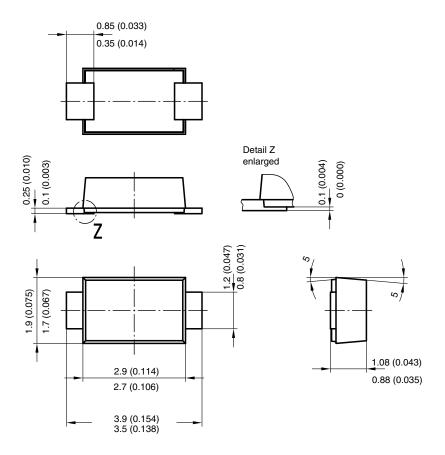


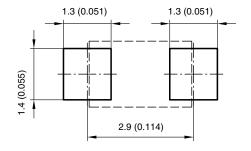
Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



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